

# MPC8640 and MPC8640D Integrated Host Processor Hardware Specifications Addendum for the MC8640xTxxyyyyyC Series

This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC8640 and MPC8640D Integrated Host Processor Hardware Specifications* (Document No. MPC8640DEC).

Specifications provided in this document supersede those in the *MPC8640 and MPC8640D Integrated Host Processor Hardware Specifications*, Rev. 1 or later, for the part numbers listed in [Table A](#) only. Specifications not addressed herein are unchanged.

Because this document is frequently updated, refer to the website listed on the back page of this document or contact your Freescale sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They are intended to correspond to the heading or table affected in the general hardware specification.

*Freescale Part Numbers Affected:*

MC8640DTHX1250HC  
 MC8640DTHX1000HC  
 MC8640DTHX1067NC  
 MC8640DTVU1250HC  
 MC8640DTVU1000HC  
 MC8640DTVU1067NC  
 MC8640THX1250HC  
 MC8640THX1000HC  
 MC8640THX1067NC  
 MC8640TVU1250HC  
 MC8640TVU1000HC  
 MC8640TVU1067NC

Part numbers addressed in this document are listed in [Table A](#).

**Table A. Part Numbers Addressed by This Data Sheet**

| Freescale Part Number | Operating Conditions |                        |                     | Significant Differences from Hardware Specification           |
|-----------------------|----------------------|------------------------|---------------------|---|
|                       | CPU Frequency (MHz)  | V <sub>DD-Core</sub> n | T <sub>j</sub> (°C) |   |
| MC8640DTHX1250HC      | 1250                 | 1.05 V ± 50 mV         | -40 to 105          | Modified JTAG AC timing; extended junction temperature range. |
| MC8640DTHX1000HC      | 1000                 | 1.05 V ± 50 mV         |                     |   |
| MC8640DTHX1067NC      | 1067                 | 0.95 V ± 50 mV         |                     |   |
| MC8640DTVU1250HC      | 1250                 | 1.05 V ± 50 mV         |                     |   |
| MC8640DTVU1000HC      | 1000                 | 1.05 V ± 50 mV         |                     |   |
| MC8640DTVU1067NC      | 1067                 | 0.95 V ± 50 mV         |                     |   |
| MC8640THX1250HC       | 1250                 | 1.05 V ± 50 mV         |                     |   |
| MC8640THX1000HC       | 1000                 | 1.05 V ± 50 mV         |                     |   |
| MC8640THX1067NC       | 1067                 | 0.95 V ± 50 mV         |                     |   |
| MC8640TVU1250HC       | 1250                 | 1.05 V ± 50 mV         |                     |   |
| MC8640TVU1000HC       | 1000                 | 1.05 V ± 50 mV         |                     |   |
| MC8640TVU1067NC       | 1067                 | 0.95 V ± 50 mV         |                     |   |

## 2 General Parameters

This section summarizes changes to the general parameters of the MPC8640 described in the *MPC8640 and MPC8640D Integrated Host Processor Hardware Specifications*.

- Modified JTAG AC timing
  - t<sub>JTDVKH</sub> (min) = 15 ns
- Extended junction temperature range
  - T<sub>J</sub> = -40 to 105 °C

### 2.1 Overall DC Electrical Characteristics

#### 2.1.2 Recommended Operating Conditions

[Table 2](#) provides the recommended operating conditions for the MPC8640 part numbers described herein.

**Table 2. Recommended Operating Conditions**

| Characteristic             | Symbol         | Recommended Value | Unit | Notes |
|----------------------------|----------------|-------------------|------|-------|
| Junction temperature range | T <sub>J</sub> | -40 to 105        | °C   | —     |

## 11.2 JTAG AC Electrical Specifications

Table 43 provides the JTAG AC electrical specifications for the MPC8640 part numbers described herein.

**Table 43. JTAG AC Timing Specifications (Independent of SYSCLK) <sup>1</sup>**

At recommended operating conditions (see Table 3).

| Parameter                      | Symbol <sup>2</sup>          | Min     | Max    | Unit | Notes |
|--------------------------------|------------------------------|---------|--------|------|-------|
| Input setup times:             |                              |         |        | ns   |       |
| Boundary-scan data<br>TMS, TDI | $t_{JTDVKH}$<br>$t_{JTIVKH}$ | 15<br>0 | —<br>— |      | 4     |

**Notes:**

- All outputs are measured from the midpoint voltage of the falling/rising edge of  $t_{TCLK}$  to the midpoint of the signal in question. The output timings are measured at the pins. All output timings assume a purely resistive 50- $\Omega$  load (see Figure 32). Time-of-flight delays must be added for trace lengths, vias, and connectors in the system.
- The symbols used for timing specifications herein follow the pattern of  $t_{(first\ two\ letters\ of\ functional\ block)(signal)(state)}$  (reference)(state) for inputs and  $t_{(first\ two\ letters\ of\ functional\ block)(reference)(state)(signal)(state)}$  for outputs. For example,  $t_{JTDVKH}$  symbolizes JTAG device timing (JT) with respect to the time data input signals (D) reaching the valid state (V) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state or setup time. Also,  $t_{JTDXKH}$  symbolizes JTAG timing (JT) with respect to the time data input signals (D) went invalid (X) relative to the  $t_{JTG}$  clock reference (K) going to the high (H) state. Note that, in general, the clock reference symbol representation is based on three letters representing the clock of a particular functional. For rise and fall times, the latter convention is used with the appropriate letter: R (rise) or F (fall).
- Non-JTAG signal input timing with respect to  $t_{TCLK}$ .

# 21 Ordering Information

## 21.1 Part Numbers Addressed by This Specification

Table 73 provides the ordering information for the MPC8640 parts described in this document.

**Table 73. Part Numbering Nomenclature**

| uu              | nnnn            | D                                    | w                    | xx  | yyyy                             | a                                       | z   |
|-----------------|-----------------|--------------------------------------|----------------------|---|----------------------------------|---|---|
| Product Code    | Part Identifier | Core Count                           | Temp                 | Package 1   | Core Processor Frequency 2 (MHz) | DDR speed (MHz)                         | Product Revision Level  |
| MC <sup>5</sup> | 8640            | Blank = Single Core<br>D = Dual Core | T:<br>-40°C to 105°C | HX = High-lead HCTE FC-CBGA<br>VU = RoHS lead-free HCTE FC-CBGA | 1000, 1067, 1250                 | N = 533 MHz <sup>4</sup><br>H = 500 MHz | Revision C = 2.1<br>System Version Register Value for Rev C:<br>0x8090_0021 - MPC8640<br>0x8090_0121 - MPC8640D |

**Notes:**

1. See Section 16, "Package," for more information on available package types.
2. Processor core frequencies supported by parts addressed by this specification only. Not all parts described in this specification support all core frequencies. Additionally, parts addressed by part number specifications may support other maximum core frequencies.
3. The P prefix in a Freescale part number designates a "Pilot Production Prototype" as defined by Freescale SOP 3-13. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.
4. Part Number MC8640xxx1067NC is our low  $V_{DD\_Core}$  device.  $V_{DD\_Core} = 0.95\text{ V}$  and  $V_{DD\_PLAT} = 1.05\text{ V}$ .
5. MC - Qualified production

## Document Revision History

Table B provides a revision history for this hardware specification addendum.

**Table B. Document Revision History**

| Rev. Number | Date    | Substantive Change(s) |
|-------------|---------|-----------------------|
| 0           | 12/2008 | Initial release.      |

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